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Kind regards,

Team Nexperia

# 1PS70SB20

# Schottky barrier single diode

**17 December 2012** 

**Product data sheet** 

# 1. General description

Planar Schottky barrier diode with an integrated guard ring for stress protection, encapsulated in a very small SOT323 (SC-70) Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- Low forward voltage
- Low capacitance
- AEC-Q101 qualified

# 3. Applications

- Ultra high-speed switching
- Line termination
- Voltage clamping
- Reverse polarity protection

## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>F</sub>	forward current		-	-	500	mA
$V_R$	reverse voltage		-	-	40	V
V <sub>F</sub>	forward voltage	$I_F$ = 500 mA; $T_{amb}$ = 25 °C	-	-	550	mV

# 5. Pinning information

Table 2. Pinning information

Tubio 2.	9	momuton		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	Α	anode	3	K
2	n.c.	not connected		A n.c.
3	К	cathode	1	aaa-005805





Schottky barrier single diode

# 6. Ordering information

#### Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
1PS70SB20	SC-70	plastic surface-mounted package; 3 leads	SOT323			

# 7. Marking

#### Table 4. Marking codes

Type number	Marking code [1]
1PS70SB20	7%2

<sup>[1] % =</sup> placeholder for manufacturing site code

# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>R</sub>	reverse voltage		-	40	V
l <sub>F</sub>	forward current		-	500	mA
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; half sine wave	-	2	Α
T <sub>j</sub>	junction temperature		-	125	°C
T <sub>amb</sub>	ambient temperature		-55	125	°C
T <sub>stg</sub>	storage temperature		-65	150	°C

## 9. Thermal characteristics

#### Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	[1]	-	-	500	K/W

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

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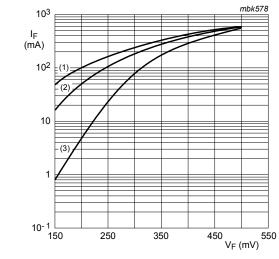
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## Schottky barrier single diode

## 10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 500 mA; T <sub>amb</sub> = 25 °C	-	-	550	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 35 V; T <sub>amb</sub> = 25 °C	-	-	100	μΑ
		$V_R$ = 35 V; pulsed; $t_p$ = 300 µs; $\delta$ = 0.02 ; $T_j$ = 100 °C	-	-	10	mA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 0 V; f = 1 MHz; T <sub>amb</sub> = 25 °C	60	-	90	pF

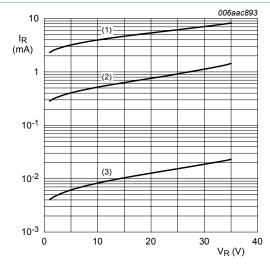




<sup>(2)</sup>  $T_{amb}$  = 85 °C

(3) 
$$T_{amb} = 25 \, ^{\circ}C$$

Fig. 1. Forward current as a function of forward voltage; typical values



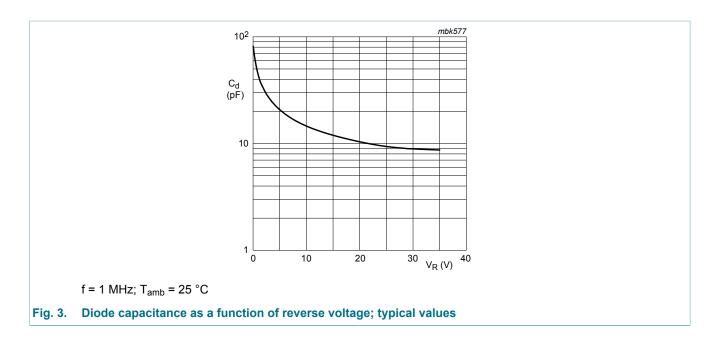
(1) 
$$T_{amb} = 125 \, ^{\circ}C$$

(2) 
$$T_{amb} = 85 \, ^{\circ}C$$

(3) 
$$T_{amb} = 25 \, ^{\circ}C$$

Fig. 2. Reverse current as a function of reverse voltage; typical values

#### Schottky barrier single diode

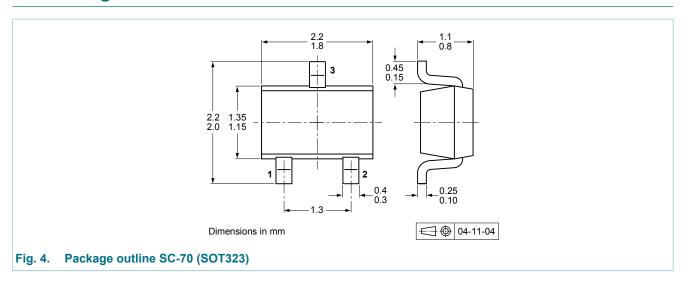


## 11. Test information

## 11.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

# 12. Package outline

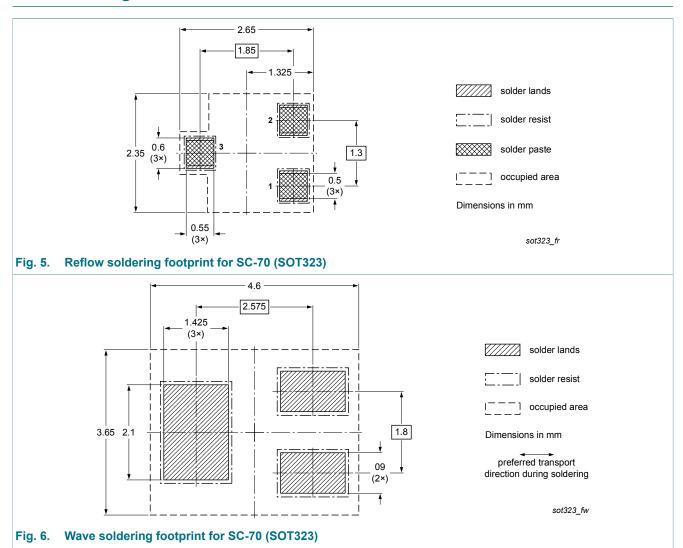


**Product data sheet** 

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### Schottky barrier single diode

# 13. Soldering



# 14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
1PS70SB20 v.2	20121217	Product data sheet	-	1PS70SB20 v.1

**Product data sheet** 

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## Schottky barrier single diode

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
Modifications:	of NXP Semicondo Legal texts have be Sections 1 to 3 up Section 4 "Quick re Section 6 "Orderin Section 7 "Marking Table 5 "Limiting verighted Section 11 "Test in Figure 4: supersect Section 13 "Solder	een adapted to the new co dated eference data" added g information" added g" updated alues": ambient temperatu formation" added ded by minimized package	ompany name where app ure T <sub>amb</sub> added	
1PS70SB20 v.1	20010316	Product data sheet	-	-

#### Schottky barrier single diode

## 15. Legal information

#### 15.1 Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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